



Material Content Data Sheet



Sales Product Name		BA 892-02V H6327		Issued		16. January 2020		
MA#		MA000763030						
Package		PG-SC79-2-1		Weight*		1.67 mg		
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	non noble metal	arsenic	7440-38-2	0.000	0.00		18	
	noble metal	gold	7440-57-5	0.003	0.18		1791	
	inorganic material	silicon	7440-21-3	0.026	1.53	1.71	15295	17104
leadframe	inorganic material	silicon	7440-21-3	0.000	0.01		92	
	non noble metal	titanium	7440-32-6	0.001	0.05		461	
	non noble metal	chromium	7440-47-3	0.002	0.14		1382	
	non noble metal	copper	7440-50-8	0.767	45.88	46.08	458876	460811
wire	non noble metal	copper	7440-50-8	0.002	0.14	0.14	1367	1367
encapsulation	organic material	carbon black	1333-86-4	0.007	0.44		4353	
	plastics	epoxy resin	-	0.124	7.40		73998	
	inorganic material	silicondioxide	60676-86-0	0.597	35.69	43.53	356929	435280
leadfinish	non noble metal	tin	7440-31-5	0.055	3.26	3.26	32641	32641
plating	noble metal	silver	7440-22-4	0.088	5.28	5.28	52797	52797
*deviation	< 10%		Sum in total:			100.00		1000000

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and does not use any exemption

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